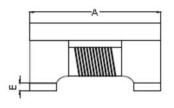
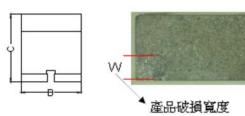


### **FEATRLRES**

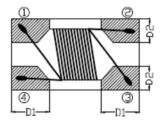
- High common mode impedance at high frequency cause excellent noise suppression performance.
- 100% Lead(Pb) & Halogen-Free and RoHS compliant.

# CONFIGRLRATIONS & DIMENSIONS (unit in mm)





當破損面積<5%,產品列入允收品範圍



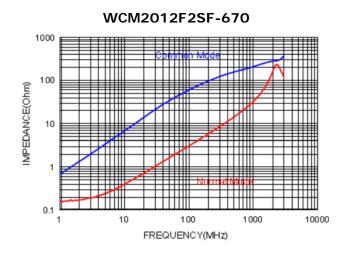
Size	Α	В	С	D1	D2	E
2012	2.0±0.2	1.2±0.2	1.2±0.2	0.5±0.1	0.5±0.1	0.15±0.1

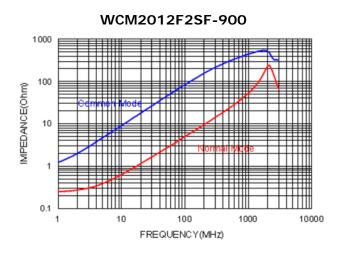
#### **ELECTRICAL CHARACTERISTICS**

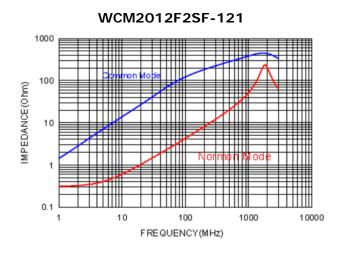
Part Number	Impedance (Ω)	Test Frequency (MHz)	DC Resistance (Ω) max.	Rated Current (mA)max.	Rated Volt. (Vdc)max.	Withstand Volt. (Vdc) max.	IR (Ω) min.
WCM2012F2SF-670T04	67±25%	100	0.25	400	50	125	10M
WCM2012F2SF-900T04	90±25%	100	0.30	400	50	125	10M
WCM2012F2SF-121T04	120±25%	100	0.30	400	50	125	10M
WCM2012F2SF-161T03	160±25%	100	0.35	350	50	125	10M
WCM2012F2SF-181T03	180±25%	100	0.35	350	50	125	10M
WCM2012F2SF-201T03	200±25%	100	0.40	300	50	125	10M
WCM2012F2SF-221T03	220±25%	100	0.40	300	50	125	10M
WCM2012F2SF-261T03	260±25%	100	0.40	300	50	125	10M
WCM2012F2SF-361T03	360±25%	100	0.50	300	50	125	10M

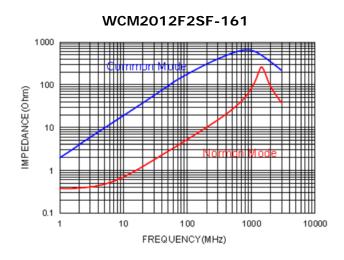


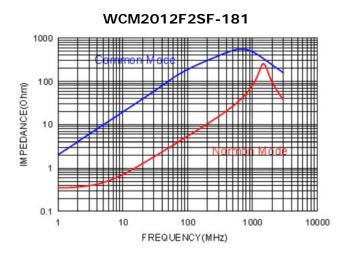
## Typical Impedance v.s. Frequency Curve

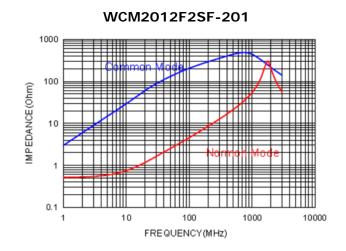




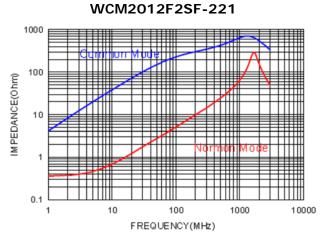


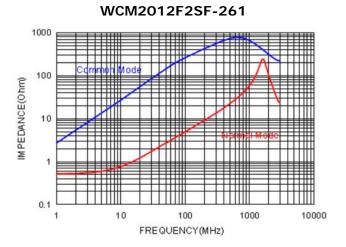




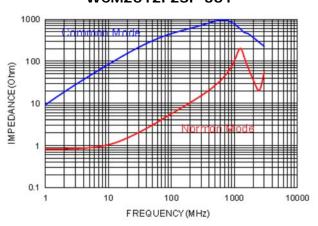












# **Reliability and Test Condition**

Item	Performance	Test Condition			
Operating temperature	-40~+125℃ (Including self - temperature rise)				
Storage temperature	110~+40℃,50~60%RH (Product with taping) 240~+125℃ (on board)				
Electrical Performance Test					
Inductance	Refer to standard electrical characteristics list.	HP4284A,CH11025,CH3302,CH1320,CH1320S LCR Meter.			
DCR	Neier to Statitual delectrical characteristics list.	CH16502,Agilent33420A Micro-Ohm Meter.			
Saturation Current (Isat)	Approximately△L30%	Saturation DC Current (Isat) will cause L0 to drop △L(%)			
Heat Rated Current (Irms)	Approximately △T40°C	Heat Rated Current (Irms) will cause the coil temperature rise $\triangle T(^{\circ}C)$ . 1.Applied the allowed DC current 2.Temperature measured by digital surface thermometer			
Reliability Test					
		Preconditioning: Run through IR reflow for 2 times.( IPC/JEDEC J-STD-020DClassification Reflow Profiles)			
Life Test		Temperature : 125±2℃(Inductor)			
Life Test		Applied current : rated current			
		Duration: 1000±12hrs			
	Appearance : No damage.	Measured at room temperature after placing for 24±2 hrs			



Inductance: within±10% of initial value	Preconditioning: Run through IR reflow for 2 times.( IPC/JEDEC J-STD-020DClassification Reflow Profiles		
·	Humidity: 85±2 * R.H,		
	Temperature : 85°C±2°C		
cxccca the specification value	Duration: 1000hrs Min. with 100% rated current		
-	Measured at room temperature after placing for 24±2 hrs		
	Preconditioning: Run through IR reflow for 2 times.( IPC/JEDEC J-STD 020DClassification Reflow Profiles  1. Baked at50℃ for 25hrs, measured at room temperature after placin for 4 hrs.		
	2. Raise temperature to 65±2°C 90-100%RH in 2.5hrs, and keep hours, cool down to 25°C in 2.5hrs.  3. Raise temperature to 65±2°C 90-100%RH in 2.5hrs, and keep hours, cool down to 25°C in 2.5hrs,keep at 25°C for 2 hrs then keep at -10°C for 3 hrs  4. Keep at 25°C 80-100%RH for 15min and vibrate at the frequency of 10 to 55 Hz to 10 Hz, measure at room temperature after placing for 1~2 hrs.		
	Preconditioning: Run through IR reflow for 2 times.( IPC/JEDEC J-STD 020DClassification Reflow Profiles Condition for 1 cycle Step1: -40±2°C 30±5min Step2: 25±2°C ≤0.5min Step3: 125±2°C 30±5min Number of cycles: 500 Measured at room temperature after placing for 24±2 hrs		
	Oscillation Frequency: 10 ~ 2K ~ 10Hz for 20 minutes  Equipment: Vibration checker  Total Amplitude:1.52mm±10%  Testing Time: 12 hours(20 minutes, 12 cycles each of 3 orientations).		
	Shall be mounted on a FR4 substrate of the following dimensions: >=0805 inch(2012mm):40x100x1.2mm <0805 inch(2012mm):40x100x0.8mm Bending depth: >=0805 inch(2012mm):1.2mm <0805 inch(2012mm):0.8mm duration of 10 sec.		
Appearance : No damage. Impedance : within±15% of initial value Inductance : within±10% of initial value Q : Shall not exceed the specification value.	Type Peak value duration (D) Wave form Velocity change (y's) (ms) Wave form (Vi)ft/sec		
RDC: within ±15% of initial value and shall not exceed the specification value	SMD         50         11         Half-sine         11.3           Lead         50         11         Half-sine         11.3		
More than 95% of the terminal electrode should be covered with solder.	Preheat: 150°C,60sec Solder: Sn96.5% Ag3% Cu0.5% Temperature: 245±5°C ∘ Flux for lead free: Rosin. 9.5% ∘ Dip time: 4±1sec ∘ Depth: completely cover the termination		
	Depth: completely cover the termination		
	Temperature ramp/immersion Number of and emersion rate heat cycles		
	260 ±5 (solder temp) 10 ±1 25mm/s ±6 mm/s 1		
Appearance: No damage. Impedance: within±15% of initial value Inductance: within±10% of initial value Q: Shall not exceed the specification value. RDC: within ±15% of initial value and shall not exceed the specification value e	Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD 020DClassification Reflow Profiles With the component mounted on a PCB with the device to be tested apply a force(>0805:1kg, <=0805:0.5kg)to the side of a device bein tested. This force shall be applied for 60 +1 seconds. Also the force shall be applied gradually as not to apply a shock to the component bein tested.		
	Q: Shall not exceed the specification value.  RDC: within ±15% of initial value and shall not exceed the specification value  Appearance: No damage. Impedance: within±15% of initial value Inductance: within±10% of initial value Q: Shall not exceed the specification value.  RDC: within ±15% of initial value and shall not exceed the specification value.  More than 95% of the terminal electrode should be covered with solder.		

Note: When there are questions concerning measurement result: measurement shall be made after 48 ± 2 hours of recovery under the standard condition.